SPECIFICATION

液晶屏规格书

Revision: 1.0

TK043F1569

好钜润科技

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1. GENERAL DESCRIPTION

The TK043F1569 is a 480(RGB)x800 dot-matrix TFT module. This module can be easily accessed by micro-processor-unit (MPU) via parallel 80-system interface and RGB interface, and is suitable for small mobile products as digital cell phone and MP4.

2. FEATURES

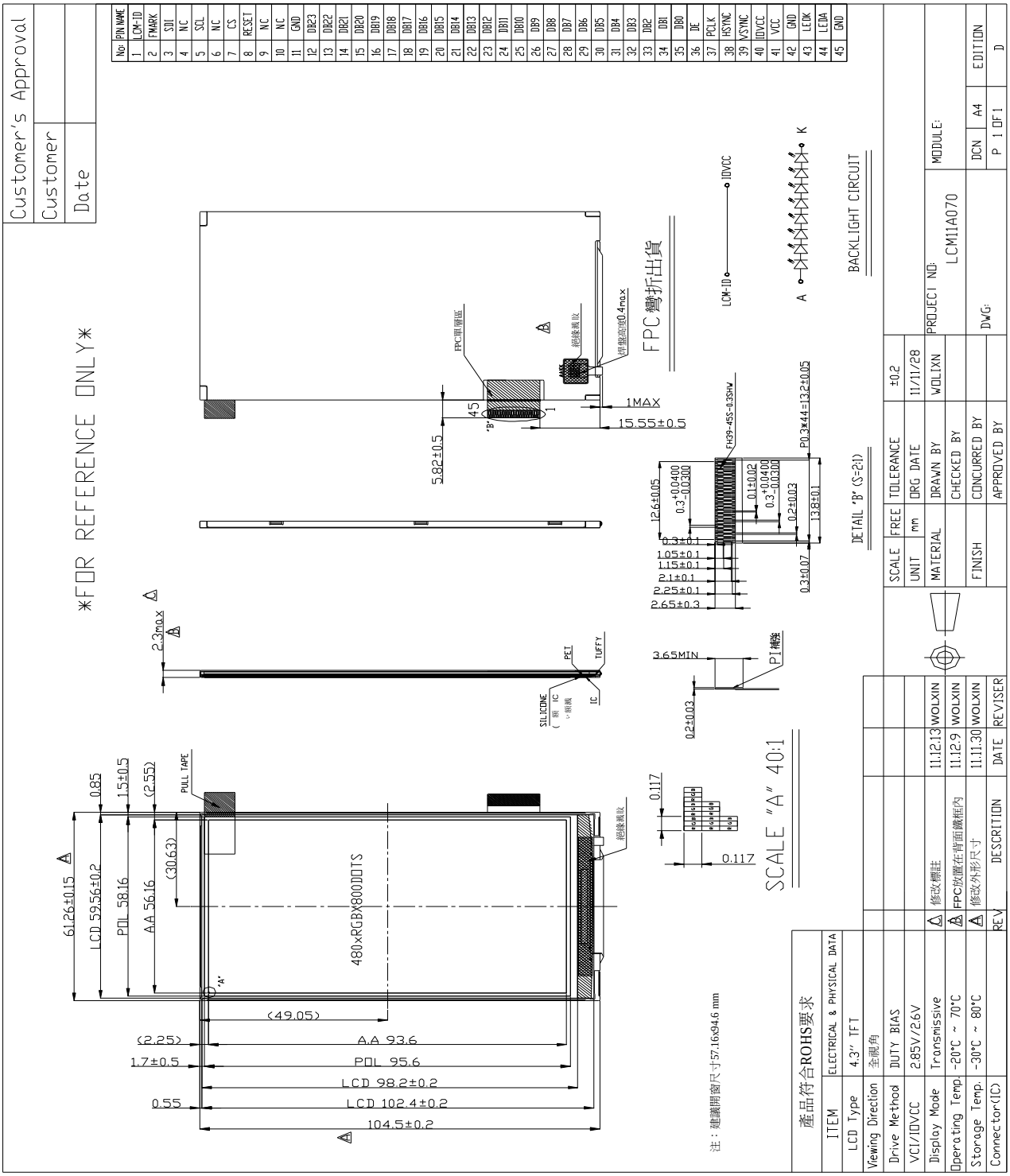
Display Mode	TFT LCD module
	Active matrix TFT ,Transmissive type
Display Format	RGB Stripe
Color	16.7M color
Input Data	RGB interface
Viewing Direction	Full viewing
Backlight	White LED
Driver IC	LG4572B

3. MECHANICAL SPECIFICATION

Item	Specifications	Unit
Dimensional outline	61.26(W)×104.5(L) ×2.3(D) (exclude FPC,include included D.S.T)	mm
Number of Pixel	480 x 800	Pixel
LCD A.A	56.16(W)×93.6 (L)	mm
Pixel Pitch	0.117 (W)×0.117(L)	mm

Note: 1 pixel = 3 dots = Red dot +Green dot +Blue dot

4. MECHANICAL DIMENSION



No	PIN NAME
1	LCM-ID
2	FMARK
3	SDI
4	NC
5	SCL
6	NC
7	CS
8	RESET
9	NC
10	NC
11	GND
12	DB23
13	DB22
14	DB21
15	DB20
16	DB19
17	DB18
18	DB17
19	DB16
20	DB15
21	DB14
22	DB13
23	DB12
24	DB11
25	DB10
26	DB9
27	DB8
28	DB7
29	DB6
30	DB5
31	DB4
32	DB3
33	DB2
34	DB1
35	DB0
36	DE
37	PCLK
38	HSYNC
39	VSYNC
40	IOVCC
41	VCC
42	GND
43	LEDK
44	LEDA
45	GND

5. MAXIMUM RATINGS

Item	Symbol	Min.	Max.	Unit	Note
Supply voltage	V_{DD}	-0.24	3.6	V	
Input Voltage	V_{IN}	-0.24	V_{DD}+0.24	V	
Operating temperature	T_{OP}	-20	70	℃	
Storage temperature	T_{ST}	-30	80	℃	
Humidity	---	-	90%	RH	MAX60℃

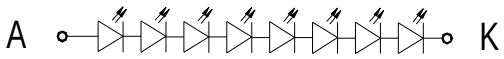
6.ELECTRICAL CHARACTERISTICS

Item		Symbol	Condition	Min.	Typ.	Max.	Unit
Supply voltage		V_{DD}	-	2.7	2.8	2.9	V
		IOVCC		1.7	1.8	1.9	V
Input Voltage	H level	V_{IH}	-	0.7xVCC	---	VCC	V
	L level	V_{IL}		0	---	0.3xVCC	V
Supply current		I_{DD}	Without LED	---	40.5	---	mA
		I_{sleep}		----	30	----	uA

7.BACKLIGHT CHARACTERISTICS

Item	Symbol	Min.	Typical	Max.	Unit
Current (One LED)	I_f	---	18	25	mA/Pcs
Number of LED ★1	---		8		Piece
Connection mode	S		Serial		---
LCM Surface Luminance ★2(I_f = 18 mA)	L_S	250	290	----	cd/㎡
LCM Surface brightness uniform★3	L_D	80	----	----	%

★1 BACKLIGHT Block diagram：



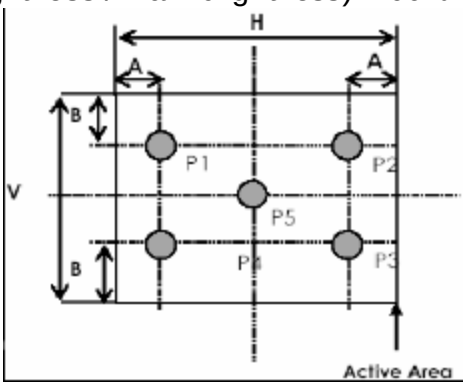
★2 Definition of Luminance:

From the LCD surface 50cm vertical suvery the center point，use BM-7 at field 1° when all pixels displaying white.

★3 Uniform measure condition：

(1)Measure 5 point. Measure location is show below：

(2)Uniform = (Min. brightness / Max. brightness)×100%



A:1/4 H

B:1/4 V

H,V:Active Area

Measurement device is TOPCON luminance meter BM-7

8. MODULE FUNCTION DESCRIPTION

8.1 PIN DESCRIPTION

Pin No	Symbol	Function
1	LCM_ID	THE ID OF LCM
2	FMARK	Out a frame head pulse signal
3	SDI	Serial data input pin and used for RGB interface mode.
4	NC	
5	SCL	Write control pin for the DBI interface. When RGB interface is selected, this pin is used as serial clock pin.
6	NC	
7	CS	Chip select. “Low” active.
8	RESET	System reset. “Low” active.
9	NC	
10	NC	
11	GND	System ground.
12-35	DB23-DB00	Data bus.
36	DE	Data enable signal in RGB interface mode.
37	PCLK	DOT clock signal in RGB interface mode.
38	HSYNC	Horizontal sync. signal in RGB interface mode.
39	VSYNC	Vertical sync. signal in RGB interface mode.
40	IOVCC	Power supply to interface pins
41	VCC	Power supply to liquid crystal power supply analog circuit.
42	GND	System ground.
43	LEDK	Cathode for back light power supply.
44	LEDA	Anode for back light power supply.
45	GND	System ground.

8.2 APPLICATION CIRC

Please consult our technical department for detail information.

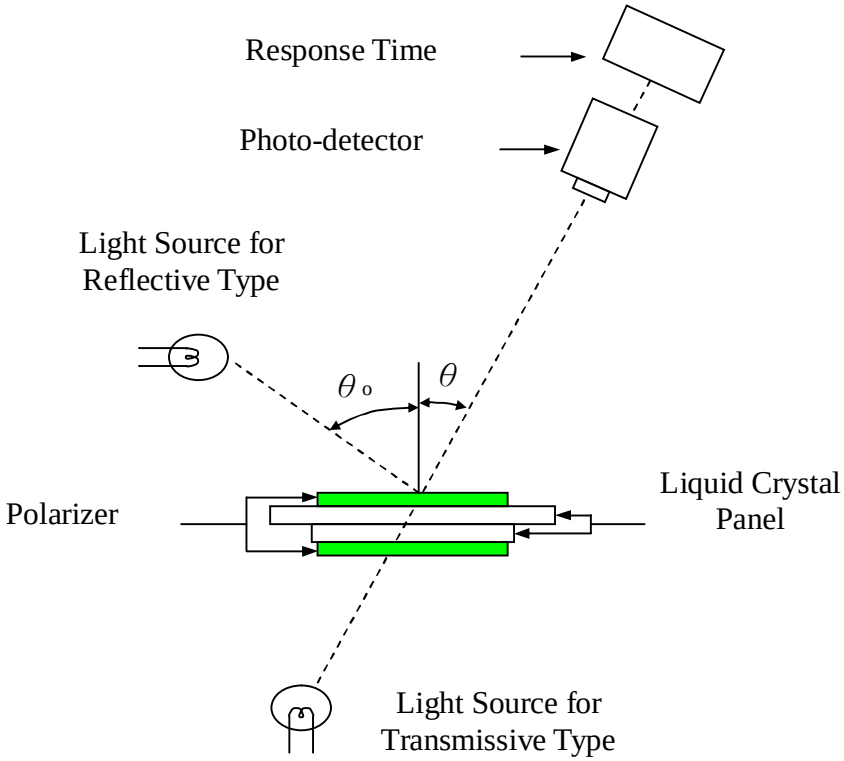
8.3 INITIAL CODE

Please consult our technical department for detail information.

9. ELECTRO-OPTICAL CHARACT ERISTICS

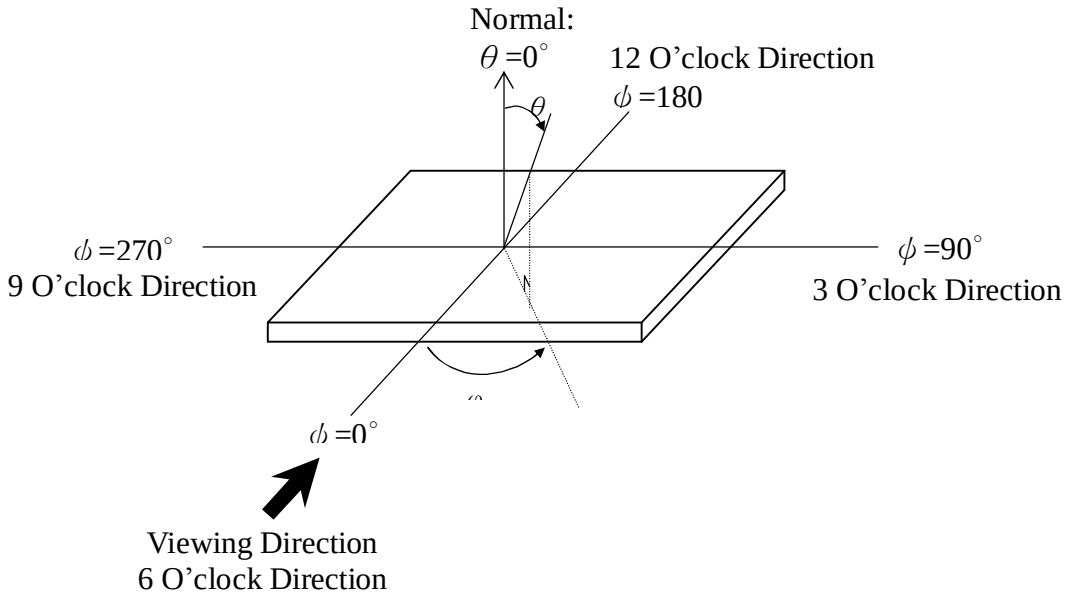
Electro-Optical Characteristics									
Item	Symbol		Condition	Temp.	Min.	Typ.	Max.	Units	Note
Viewing Angle Range	θ		ψ= 0° ψ= 90° ψ= 180° ψ= 270° (CR≧10)	25℃	---- ---- ---- ----	70 70 70 70	---- ---- ---- ----	degree	Note 2
Response Time	Rise Time (Tr)		θ=ψ= 0° θ_0 = 25°	25℃	----	20	----	msec	Note 1,4
	Fall Time (Tf)				----	15	----		
Module Chromaticity	White	x	θ=ψ= 0°	25℃	0.26	0.2940	0.30	---	Note 3
		y			0.30	0.3288	0.34		
	Red	x			----	TBD	----		
		y			----		----		
	Green	x			----		----		
		y			----		----		
	Blue	x			----		----		
		y			----		----		
Module Contrast Ratio	CR		θ=ψ= 0°	25℃		650		---	Note3, 5

Note 1: Electro-Optical Characteristics Test Method.



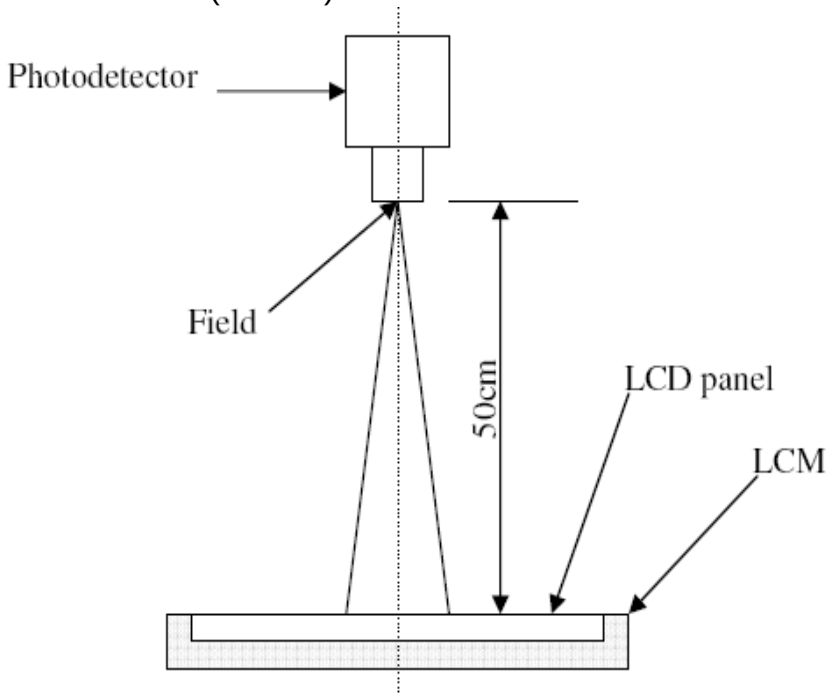
Note 2: Definition of Viewing Angel.

Viewing angle is the angle at which the contrast ratio is greater than 2,for TFT module thecontrast ratio is greater than 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface.



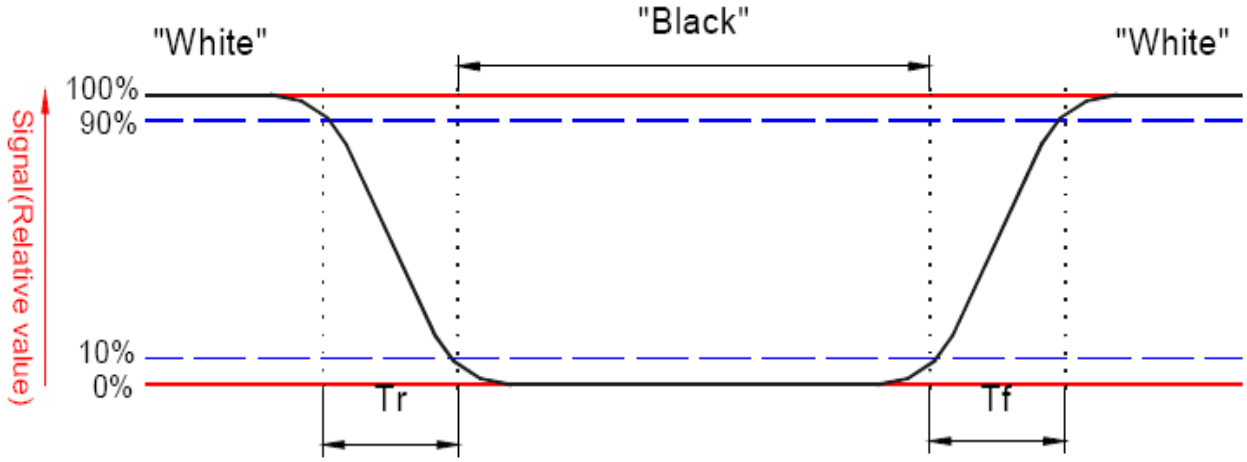
Note 3: Optical measurement equipment setup

-Measurement should be executed in a stable, windless, and dark room. After lighting thebacklight for 30mins.
-Environment condition : Common air conditioner cleanness Ta=25±5
Humidity=60±15%
-Distance : 50cm
-Photodetector : BM-7 (Field 1°)



Note 4: Definition of Optical Response Time

The output signals of photo detector are measured when the input signals are changed from “black” to “white”(falling time) and from “white” to “black”(rising time), respectively. The response time is defined as the time interval between the 10% and 90% of amplitudes. Refer to figure as below:



Note 5: Definition of Contrast Ratio (CR).

Contrast ratio is calculated with the following formula.

$$\text{Contrast ratio (CR)} = \frac{\text{Photo detector output when LCD is at “White” state}}{\text{Photo detector output when LCD is at “Black” state}}$$

10. RELIABILITY

10.1. MTBF

The LCD module shall be designed to meet a minimum MTBF value of 50000 hours with normal. (25°C in the room without sunlight)

10.2. Test condition

NO.	ITEM	CONDITION	CRITERION
1	High Temperature Non-Operating Test	80℃ * 240Hrs	◦ No defect of operational functions in room temperature are allowable. ◦ IDD of LCM should be below specification.
2	Low Temperature Non-Operating Test	-30℃ * 240Hrs	
3	High Temperature/Humidity Operating Test	50℃ * 90%RH * 240 Hrs	
4	High Temperature Operating Test	70℃ * 240Hrs	
5	Low Temperature Operating Test	-20℃ * 240Hrs	
6	Thermal Shock Test	-30℃(30Min)↔ 80(30Min)* 10 Cycles	
7	ESD Test	Air discharge:±6KV Contact discharge:±4KV	

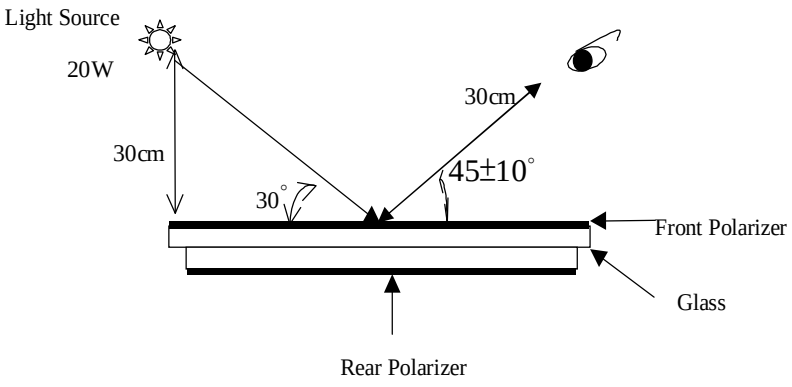
Notes:
1.Judgments should be made after exposure in room temperature for two hours.
2.The pure water is used for the high temperature / humidity test.
3.The sample above is individually for every reliability tests condition.

11. INSPECTION CRITERIA

1. AQL(Acceptable Quality Level)
   AQL of major and minor defect

	MAJOR DEFECT	MINOR DEFECT	MAJOR+MINOR
APPEARANCE	0.40%	1.0%	1.0%
ELECTRIC-OPTICAL	0.15%	0.15%	0.15%

2. Basic conditions for inspection
   The LCM face to us, According to the criteria of luminance measurement instruction, About an angle of incidence 30,a distence of 30 cm with normal eye.with an angle of 45 degree to check the products without uncovering the film!
   (As shown below).

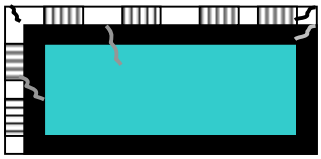
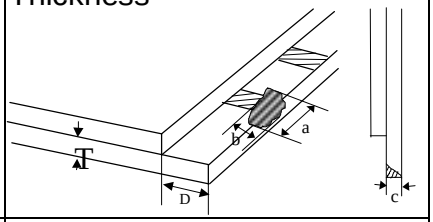
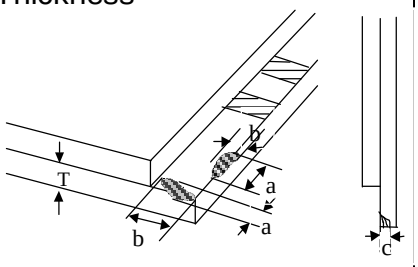
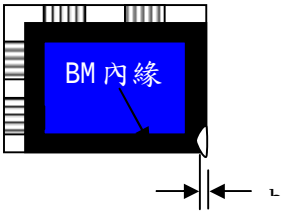


3. Inspection item and criteria

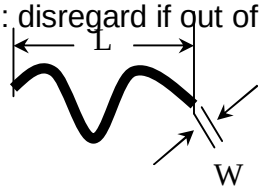
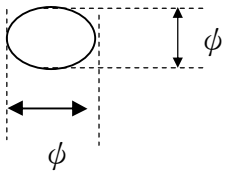
3.1 Visual inspection criterion in immobility

3.1.1 Glass defect

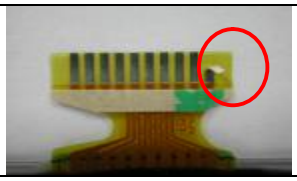
No	Defect item	Criteria	Remark
1	Dimension Unconformity (Major defect)	By Engineering Drawing	

No	Defect item	Criteria	Remark
2	Cracks (Major defect)	1)Not-extended crack according to the limit sample 2) Extended crack when C≦T and the crack touch ≦1/3 sealant width is OK	
3	Glass extrude the conductive area (minor defect)	a: disregards and no influence assemblage 1) b≦1/3Pin width(non bonding area) 【Accept】 2) bonding area≦0.5mm 【Accept】	a:Length, b:Width
4	Pin-side，conductive area damaged (minor defect)	(a c：disregards) b≦ 1/3 of effective length for bonding electrode 【Accept】	a：Length，b：Width，c：Thickness 
5	Pin-side，non-conductive area damaged (minor defect)	1) Damage area don't touch the ITO (Inclueling contraposition mark,except scribing mark) 【Accept】 2) c<T b≦BM 1/3 of width 【Accept】 3) c=T b not touch the seal glue 【Accept】 4) a disregards	a：Length，b：Width，c：Thickness 
6	Non-pin-side damage (minor defect)	c<T 1) b exceeds 1/3 BM 【Reject】 c=T b not touch the seal glue 【Accept】	c： Thickness b: width of damage 

3.1.2 LCD appearance defect (View area)

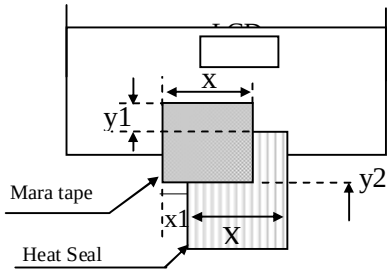
No	Defect item	Criteria		Remark
1	Fiber、glass cratch、polarizer scratch/folded (minor defect)	Specification	Allowable	note1: L：Length，W：Width note2: disregard if out of AA 
		W≦0.03mm	disregard	
		0.03mm<W≦0.05mm ; L≦3.0mm	2	
		0.05mm<W≦0.1mm; L≦3.0mm	1	
		W>0.1mm ; L>3.0mm	0	
2	Polarizer bubble、concave and convex (minor defect)	ψ≦0.2mm	disregard	note 1:ψ=(L+W)/2；L：Length，W：Width note2: disregard if out of AA
		0.2mm<ψ ≦ 0.3mm	2	
		0.3mm<ψ ≦ 0.5mm	1	
		0.5mm<ψ	0	
3	Black dots、dirty dots、impurities、eyewinker (Major defect)	ψ≦0.10mm	disregard	note 1: disregard if out of AA note2: Inspection by RGB pattern 
		0.1mm<ψ≦0.15mm	2	
		0.15<ψ≦0.2mm	1	
4	Polarizer prick (Major defect)	ψ≦0.1mm	disregard	note1:ψ=(L+W)/2 ； L= Length，W=Width note2: the distance between two dots ＞5mm
		0.1mm<ψ≦0.25mm	3	
		ψ＞0.25mm	0	

3.1.3 .FPC

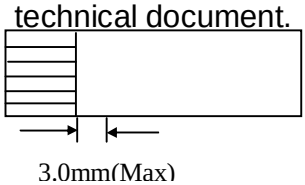
No	Defect item	Criteria		Remark
1	Copper screen peel (Major defect)	Copper screen peel 【Reject】		
2	No release tape or peel (Major defect)	No release tape or peel 【Reject】		
3	Dirty dot and impurity of FPC for customer using side (minor defect)	Specification	Allowable	note1: Cannot have stride ITO impurities
		ψ≦0.25mm	2	
		ψ>0.25	0	

3.1.4 Black tape & Mara tape

No	Defect item	Criteria	Remark

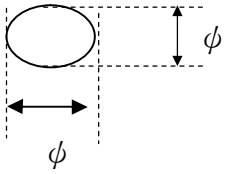
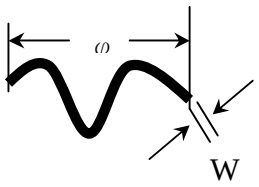
No	Defect item	Criteria	Remark
1	FPC or H/S black tape shift (minor defect)	1.shift spec: 1)glue to the polarize 【Reject】 2) IC bare 【Reject】 2. left-and-right spec: 1) exceed of FPC edge or H-S edge 【Reject】 2)IC bare 【Reject】	
2	No black tape (Major defect)	No black tape 【Reject】	
3	Tape position mistake (minor defect)	Not by engineering drawing 【Reject】	
4	Mara tape defect (minor defect)	Peel before pulling the protecting film. 【Reject】	

3.1.5 Silicon and Tuffy glue

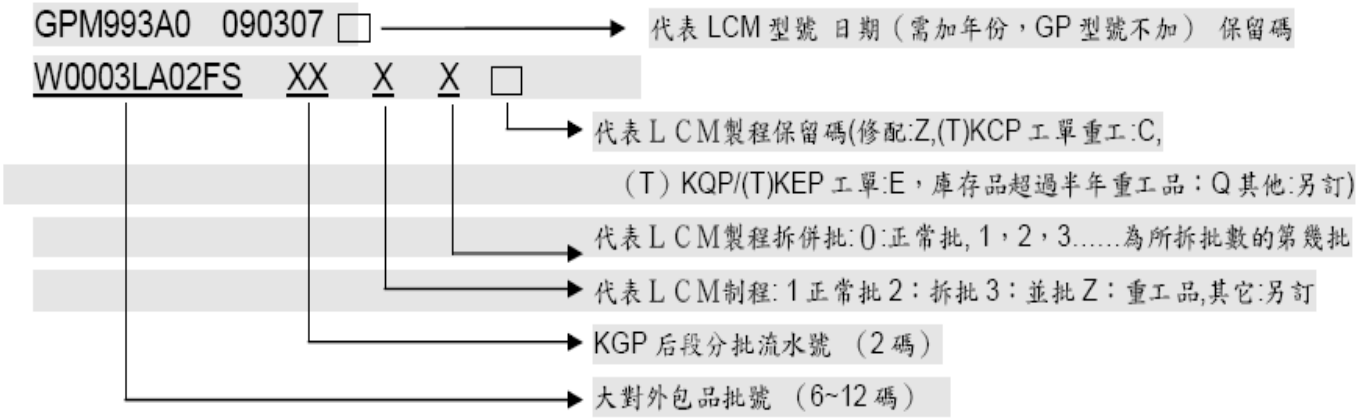
No	Defect item	Criteria	Remark
1	Quantity of silicon (minor defect)	Uncover the ITO and circuit area. 【Reject】	note: compared by engineering drawing.
2	Tuffy glue (minor defect)	1. Uncover the reveal copper area 【Reject】 2. Cover layer 0.3mm(Min) ~ 3.0mm(Max) 【accept】	note:if customer has special requirement , refer to the technical document. 
3	Depth of glue covering (minor defect)	Depth of glue covering overtop front Polarizer 【Reject】	Except of the special requirement。

3.2 Electrical criteria

No	Defect item	Criteria	Remark
1	No display (Major defect)	No display 【Reject】	
2	Missing line (Major defect)	Missing line 【Reject】	

No	Defect item	Criteria		Remark
3	Seg-com light and dark (Major defect)	Seg-com light and dark 【Reject】		
4	No display in immobility (Major defect)	No display in immobility 【Reject】		
5	Flicker of Pattern (Major defect)	Flicker of Pattern 【Reject】		
6	Over current (Major defect)	Over current 【Reject】		
7	Voltage out of specification (Major defect)	Voltage out of specification 【Reject】		
8	Pattern blur ,error code (Major defect)	Pattern blur ,error code 【Reject】		
9	Dark light, Flicker (Major defect)	Dark light, Flicker 【Reject】		
10	Black/White dots 、Dirty dots、eyewinker (Major defect)	Specification	Allowable	Note1: disregard if out of AA note2: Inspection by RGB pattern 
		ψ≦0.10mm	disregard	
		0.10mm<ψ ≦ 0.15mm	2	
		0.15mm<ψ ≦ 0.2mm	1	
11	Fiber、glass cratch、polarizer scratch/folded (minor defect)	W≦0.03mm	disregard	note1: L：Length，W：Width note2: disregard if out of AA 
		0.03mm<W≦0.05mm ; L≦3.0mm	2	
		0.05mm<W≦0.1mm; L≦3.0mm	1	
		W>0.1mm ; L>3.0mm	0	

12. ILLUSTRATION OF LCD DATE CODE



13. PRECAUTIONS FOR USE

13.1 SAFETY

(1) Do not swallow any liquid crystal, even if there is no proof that liquid crystal is poisonous.

(2) If the LCD panel breaks, be careful not to get liquid crystal to touch your skin.

(3) If skin is exposed to liquid crystal, wash the area thoroughly with alcohol or soap.

13.2 STORAGE CONDITIONS

(1) Store the panel or module in a dark place where the temperature is 23±5°C and the humidity is below 45±20%RH.
(2) Store in anti-static electricity container.
(3) Store in clean environment, free from dust, active gas, and solvent.
(4) Do not place the module near organics solvents or corrosive gases.
(5) Do not crush, shake, or jolt the module.

13.3 HANDLING PRECAUTIONS

(1) Avoid static electricity, which can damage the CMOS LSI.

(2) The polarizin plate of the display is very fragile. so, please handle if very carefully.

(3) Do not give external shock.

(4) Do not apply excessive force on the surface.

(5) Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.

(6) Do not use ketonics solvent & Aromatic solvent, use with a soft cloth soaked with a cleaning naphtha solvent.

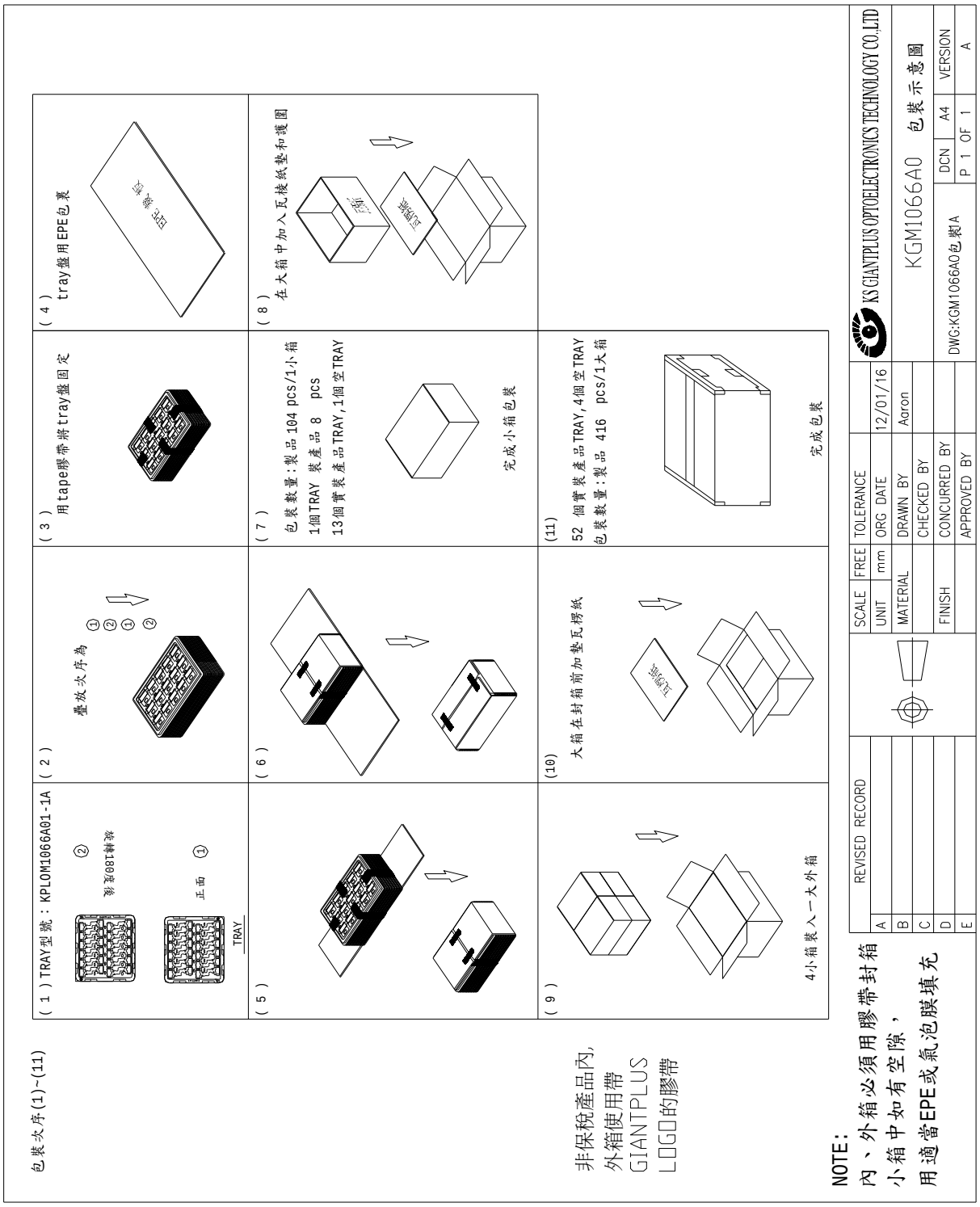
(7) Do not operate it above the absolute maximum rating.

(8) Do not remove the panel or frame from the module.

13.4 WARRANTY

The period is within twelve months since the date of shipping out under normal using and storage conditions.

14. MARK AND PACKAGING



15. FACTORY

For the consideration of mass production convenience, this module will by manufactured in the factory below.

FACTORY NAME:HOLOCENE TECHNOLOGY Co.
工厂名称:好钜润科技有限公司
FACTORY ADDRESS:
工厂地址：
深圳市龙华新区清湖雪岗北路366号
P.C: 516600 URL: www.hjrkj.com
邮政编码：516600 网站:www.hjrkj.com
FACTORY PHONE: TEL: 86-755-33561760

16. REVISION HISTORY

Rev NO.	Revise record	Rev Date
1.0	Original revision	2017/11/08